



## **PRESS RELEASE**

### **BE Semiconductor Industries Announces Transactions Under Share Repurchase Program**

Duiven, the Netherlands, June 25, 2021 - BE Semiconductor Industries N.V. (the "Company" or "Besì") (Euronext Amsterdam: BESI; OTC: BESIY - Nasdaq International Designation) reports the following transactions, conducted under Besì's current share repurchase program.

| <b>Date</b> | <b>Total repurchased shares</b> | <b>Weighted average price (in euro)</b> | <b>Total repurchased value (in euro)</b> |
|-------------|---------------------------------|-----------------------------------------|------------------------------------------|
| 18-Jun-21   | 2,248                           | 71.16                                   | 159,966.33                               |
| 21-Jun-21   | 2,301                           | 69.51                                   | 159,936.07                               |
| 22-Jun-21   | 2,320                           | 68.97                                   | 160,005.30                               |
| 23-Jun-21   | 2,321                           | 68.93                                   | 159,995.35                               |
| 24-Jun-21   | 2,302                           | 69.53                                   | 160,054.15                               |
| 25-Jun-21   | 2,288                           | 69.90                                   | 159,938.98                               |

The share repurchases are part of a € 75 million share repurchase program announced on July 26, 2018. On July 28, 2020, the Company announced the extension of its current share buyback program until October 30, 2021 and an increase in its total amount from € 75 million to € 125 million. Details are available on our website at <https://www.besi.com/investor-relations/share-repurchase-program/>.

This regular update of the transactions conducted under the share repurchase program is made public under the Market Abuse Regulation (No. 596/2014/EU).

#### **About Besì**

Besì is a leading supplier of semiconductor assembly equipment for the global semiconductor and electronics industries offering high levels of accuracy, productivity and reliability at a low cost of ownership. The Company develops leading edge assembly processes and equipment for leadframe, substrate and wafer level packaging applications in a wide range of end-user markets including electronics, mobile internet, cloud server, computing, automotive, industrial, LED and solar energy. Customers are primarily leading semiconductor manufacturers, assembly subcontractors and electronics and industrial companies. Besì's ordinary shares are listed on Euronext Amsterdam (symbol: BESI). Its Level 1 ADRs are listed on the OTC markets (symbol: BESIY Nasdaq International Designation) and its headquarters are located in Duiven, the Netherlands. For more information, please visit our website at [www.besi.com](http://www.besi.com).

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